

## SCBS087C – FEBRUARY 1991 – REVISED JANUARY 1997

- SN54ABT16543 . . . WD PACKAGE  
SN74ABT16543 . . . DGG OR DL PACKAGE  
(TOP VIEW)

# SN54ABT16543, SN74ABT16543

## 16-BIT REGISTERED TRANSCEIVERS

### WITH 3-STATE OUTPUTS

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FUNCTION TABLE†  
(each 8-bit section)

INPUTS				OUTPUT B
$\overline{\text{CEAB}}$	$\overline{\text{LEAB}}$	$\overline{\text{OEAB}}$	A	
H	X	X	X	Z
X	X	H	X	Z
L	H	L	X	$B_0^\ddagger$
L	L	L	L	L
L	L	L	H	H

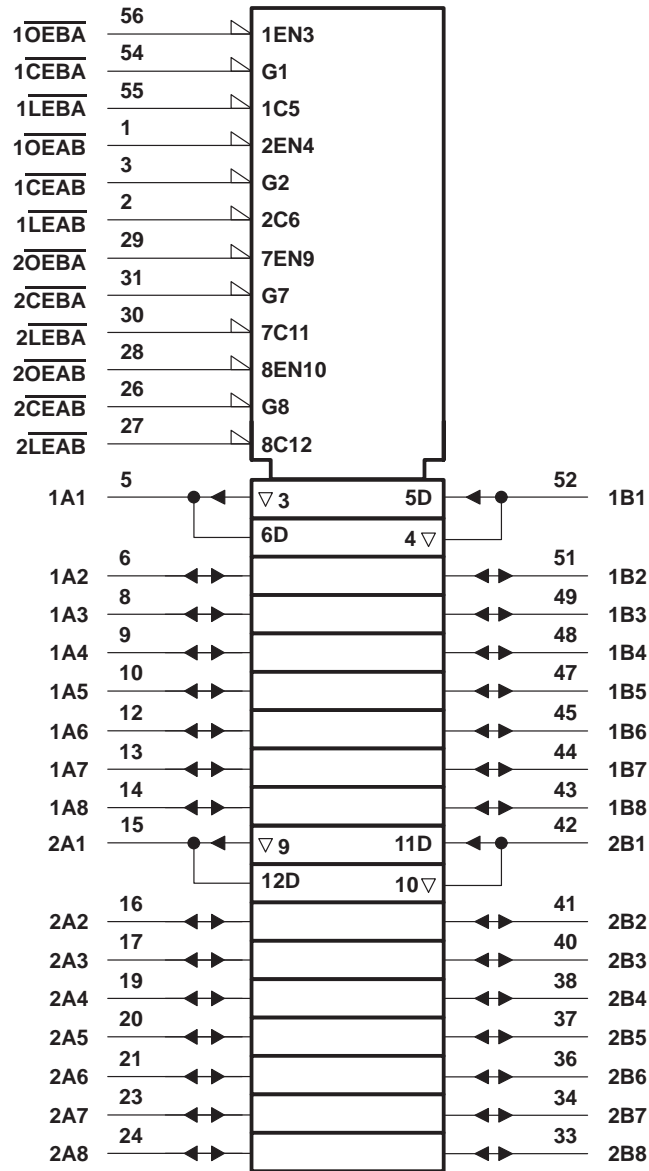
† A-to-B data flow is shown;  $\overline{\text{B-to-A}}$  flow control is the same except that it uses  $\overline{\text{CEBA}}$ ,  $\overline{\text{LEBA}}$ , and  $\overline{\text{OEBA}}$ .

‡ Output level before the indicated steady-state input conditions were established

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16-BIT REGISTERED TRANSCEIVERS  
WITH 3-STATE OUTPUTS

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logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

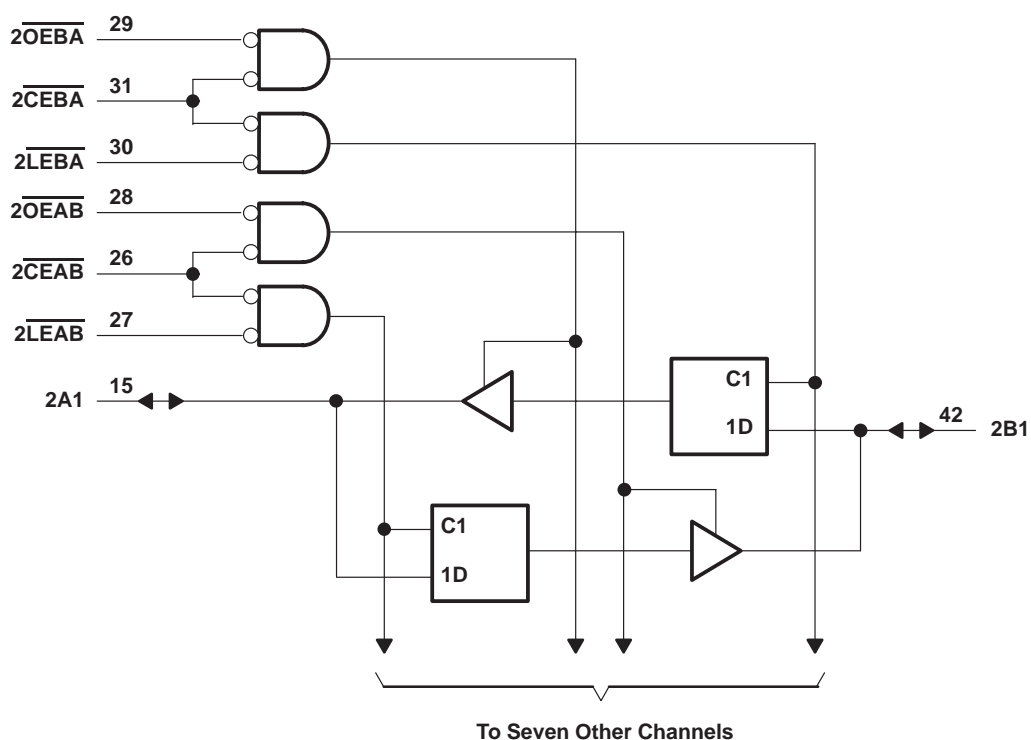
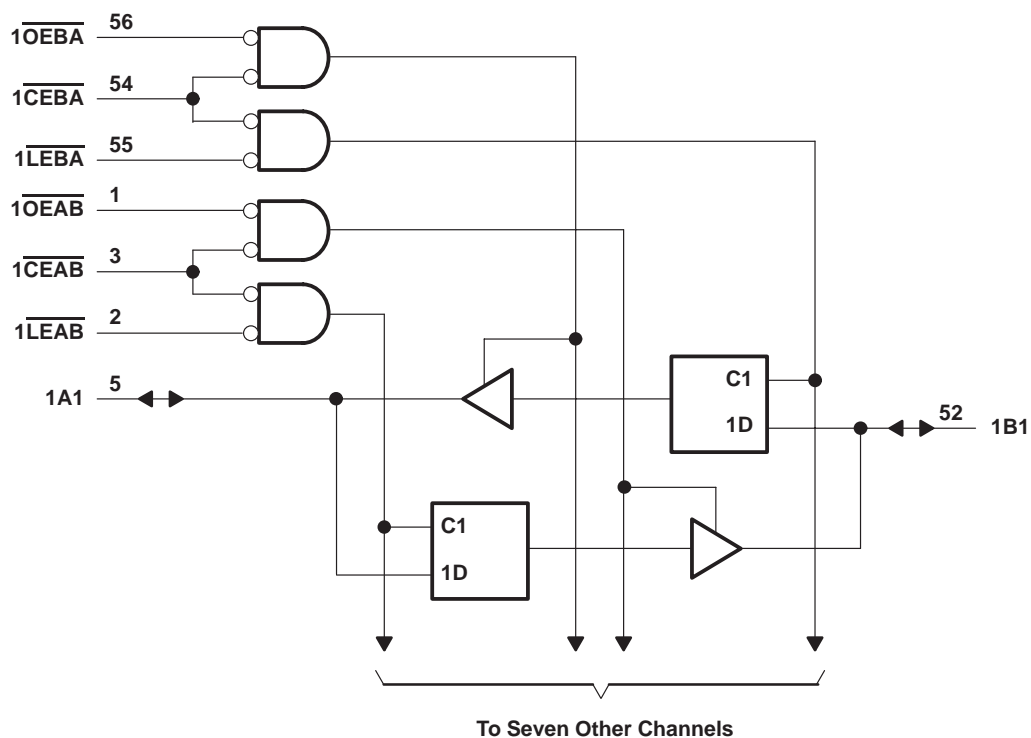
# SN54ABT16543, SN74ABT16543

## 16-BIT REGISTERED TRANSCEIVERS

### WITH 3-STATE OUTPUTS

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#### logic diagram (positive logic)



# SN54ABT16543, SN74ABT16543 16-BIT REGISTERED TRANSCEIVERS WITH 3-STATE OUTPUTS

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## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage range, $V_{CC}$	–0.5 V to 7 V
Input voltage range, $V_I$ (except I/O ports) (see Note 1)	–0.5 V to 7 V
Voltage range applied to any output in the high or power-off state, $V_O$	–0.5 V to 5.5 V
Current into any output in the low state, $I_O$ : SN54ABT16543	96 mA
SN74ABT16543	128 mA
Input clamp current, $I_{IK}$ ( $V_I < 0$ )	–18 mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ )	–50 mA
Package thermal impedance, $\theta_{JA}$ (see Note 2): DGG package	81°C/W
DL package	74°C/W
Storage temperature range, $T_{stg}$	–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.  
2. The package thermal impedance is calculated in accordance with EIA/JEDEC Std JESD51.

## recommended operating conditions (see Note 3)

		SN54ABT16543		SN74ABT16543		UNIT
		MIN	MAX	MIN	MAX	
$V_{CC}$	Supply voltage	4.5	5.5	4.5	5.5	V
$V_{IH}$	High-level input voltage	2		2		V
$V_{IL}$	Low-level input voltage		0.8		0.8	V
$V_I$	Input voltage	0	$V_{CC}$	0	$V_{CC}$	V
$I_{OH}$	High-level output current		–24		–32	mA
$I_{OL}$	Low-level output current		48		64	mA
$\Delta t/\Delta v$	Input transition rise or fall rate		10		10	ns/V
	Outputs enabled					
$T_A$	Operating free-air temperature	–55	125	–40	85	°C

NOTE 3: Unused pins (input or I/O) must be held high or low to prevent them from floating.



# SN54ABT16543, SN74ABT16543

## 16-BIT REGISTERED TRANSCEIVERS

### WITH 3-STATE OUTPUTS

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**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

PARAMETER		TEST CONDITIONS		T <sub>A</sub> = 25°C			SN54ABT16543		SN74ABT16543		UNIT
				MIN	TYP†	MAX	MIN	MAX	MIN	MAX	
V <sub>IK</sub>		V <sub>CC</sub> = 4.5 V, I <sub>I</sub> = -18 mA				-1.2		-1.2		-1.2	V
V <sub>OH</sub>		V <sub>CC</sub> = 4.5 V, I <sub>OH</sub> = -3 mA		2.5			2.5		2.5		V
		V <sub>CC</sub> = 5 V, I <sub>OH</sub> = -3 mA		3			3		3		
		V <sub>CC</sub> = 4.5 V	I <sub>OH</sub> = -24 mA	2			2				
			I <sub>OH</sub> = -32 mA	2*					2		
V <sub>OL</sub>		V <sub>CC</sub> = 4.5 V	I <sub>OL</sub> = 48 mA			0.55		0.55			V
			I <sub>OL</sub> = 64 mA			0.55*				0.55	
V <sub>hys</sub>						100					mV
I <sub>I</sub>	Control inputs	V <sub>CC</sub> = 5.5 V, V <sub>I</sub> = V <sub>CC</sub> or GND				±1		±1		±1	μA
	A or B ports					±100		±100		±100	
I <sub>OZH</sub> ‡		V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 2.7 V				50**		10		50	μA
I <sub>OZL</sub> ‡		V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 0.5 V				-50**		-10		-50	μA
I <sub>off</sub>		V <sub>CC</sub> = 0, V <sub>I</sub> or V <sub>O</sub> ≤ 4.5 V				±100				±100	μA
I <sub>CEX</sub>		V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 5.5 V	Outputs high			50		50		50	μA
I <sub>O</sub> §		V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 2.5 V		-50	-100	-200	-50	-200	-50	-200	mA
I <sub>CC</sub>	A or B ports	V <sub>CC</sub> = 5.5 V, I <sub>O</sub> = 0, V <sub>I</sub> = V <sub>CC</sub> or GND	Outputs high			2		2		2	mA
			Outputs low			35		35		35	
			Outputs disabled			2		2		2	
ΔI <sub>CC</sub> ¶		V <sub>CC</sub> = 5.5 V, One input at 3.4 V, Other inputs at V <sub>CC</sub> or GND				0.5		0.5		0.5	mA
C <sub>i</sub>	Control inputs	V <sub>I</sub> = 2.5 V or 0.5 V				3					pF
C <sub>io</sub>	A or B ports	V <sub>O</sub> = 2.5 V or 0.5 V				8.5					pF

\* On products compliant to MIL-PRF-38535, this parameter does not apply.

\*\* These limits apply only to the SN74ABT16543.

† All typical values are at V<sub>CC</sub> = 5 V.

‡ The parameters I<sub>OZH</sub> and I<sub>OZL</sub> include the input leakage current.

§ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

¶ This is the increase in supply current for each input that is at the specified TTL voltage level rather than V<sub>CC</sub> or GND.

**timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)**

		V <sub>CC</sub> = 5 V, T <sub>A</sub> = 25°C		SN54ABT16543		SN74ABT16543		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	
t <sub>w</sub>	Pulse duration, $\overline{\text{LEAB}}$ or $\overline{\text{LEBA}}$ low	4		4		4		ns
t <sub>su</sub>	Setup time, data before $\overline{\text{LEAB}}\uparrow$ or $\overline{\text{LEBA}}\uparrow$	High	1.5	1.5		1.5		ns
		Low	3.5	3.5		3.5		
t <sub>h</sub>	Hold time, data after $\overline{\text{LEAB}}\uparrow$ or $\overline{\text{LEBA}}\uparrow$	High	1.5	1.5		1.5		ns
		Low	2	2		2		



**SN54ABT16543, SN74ABT16543**  
**16-BIT REGISTERED TRANSCEIVERS**  
**WITH 3-STATE OUTPUTS**

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switching characteristics over recommended ranges of supply voltage and operating free-air temperature,  $C_L = 50$  pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN54ABT16543					UNIT
			V <sub>CC</sub> = 5 V, T <sub>A</sub> = 25°C			MIN	MAX	
			MIN	TYP	MAX			
t <sub>PLH</sub>	A or B	B or A	0.8	2.5	3.3	0.8	3.9	ns
t <sub>PHL</sub>			0.9	2.7	4.4	0.9	5.2	
t <sub>PLH</sub>	$\overline{LE}$	A or B	1	3.1	4.3	1	5.3	ns
t <sub>PHL</sub>			1.2	3.3	4.8	1.2	5.7	
t <sub>PZH</sub>	$\overline{OE}$	A or B	0.8	3.4	4.3	0.8	5.3	ns
t <sub>PZL</sub>			1.1	3.8	7	1.1	7.9	
t <sub>PHZ</sub>	$\overline{OE}$	A or B	1.9	4	6.3	1.9	7.2	ns
t <sub>PLZ</sub>			1.6	3.3	4.6	1.6	5	
t <sub>PZH</sub>	$\overline{CE}$	A or B	0.9	3.8	4.9	0.9	6.3	ns
t <sub>PZL</sub>			1.2	4.2	6.8	1.2	7.9	
t <sub>PHZ</sub>	$\overline{CE}$	A or B	2	4.5	6.4	2	7.3	ns
t <sub>PLZ</sub>			1.7	3.9	5.1	1.7	5.6	

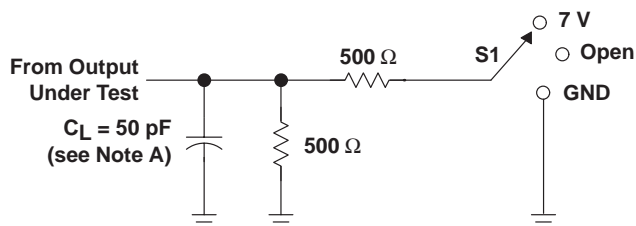
switching characteristics over recommended ranges of supply voltage and operating free-air temperature,  $C_L = 50$  pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN74ABT16543					UNIT
			V <sub>CC</sub> = 5 V, T <sub>A</sub> = 25°C			MIN	MAX	
			MIN	TYP	MAX			
t <sub>PLH</sub>	A or B	B or A	1	2.5	3.3	1	3.8	ns
t <sub>PHL</sub>			1	2.7	4.4	1	5.1	
t <sub>PLH</sub>	$\overline{LE}$	A or B	1	3.1	4.3	1	5.2	ns
t <sub>PHL</sub>			1.2	3.3	4.8	1.2	5.6	
t <sub>PZH</sub>	$\overline{OE}$	A or B	1	3.4	4.3	1	5.2	ns
t <sub>PZL</sub>			1.1	3.8	5.9	1.1	7	
t <sub>PHZ</sub>	$\overline{OE}$	A or B	1.9	4	5	1.9	5.7	ns
t <sub>PLZ</sub>			1.6	3.3	4.2	1.6	4.6	
t <sub>PZH</sub>	$\overline{CE}$	A or B	1	3.8	4.9	1	6.2	ns
t <sub>PZL</sub>			1.2	4.2	6.5	1.2	7.8	
t <sub>PHZ</sub>	$\overline{CE}$	A or B	2	4.5	5.6	2	6.6	ns
t <sub>PLZ</sub>			1.7	3.9	5.1	1.7	5.4	

# SN54ABT16543, SN74ABT16543 16-BIT REGISTERED TRANSCIEVERS WITH 3-STATE OUTPUTS

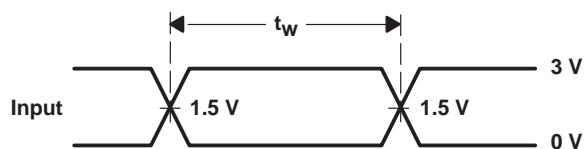
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## PARAMETER MEASUREMENT INFORMATION

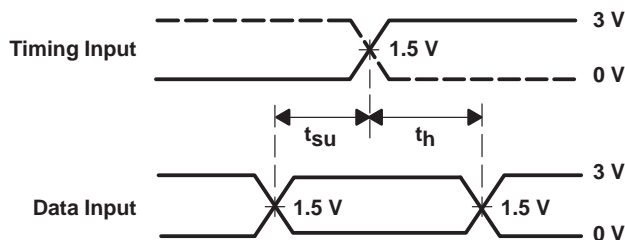


LOAD CIRCUIT

TEST	S1
$t_{PLH}/t_{PHL}$	Open
$t_{PLZ}/t_{PZL}$	7 V
$t_{PHZ}/t_{PZH}$	Open



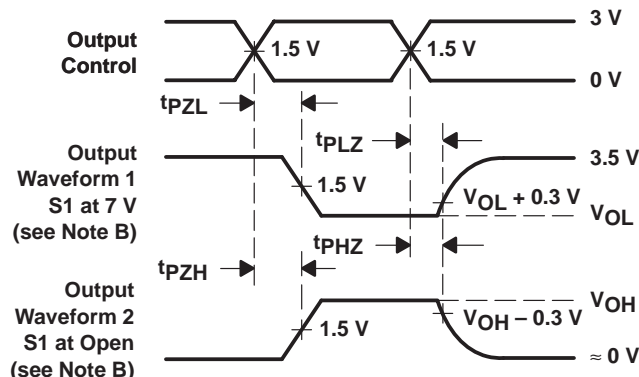
VOLTAGE WAVEFORMS  
PULSE DURATION



VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES  
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES  
LOW- AND HIGH-LEVEL ENABLING

- NOTES: A.  $C_L$  includes probe and jig capacitance.  
B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.  
C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r \leq 2.5 \text{ ns}$ ,  $t_f \leq 2.5 \text{ ns}$ .  
D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



## PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
5962-9324101MXA	ACTIVE	CFP	WD	56	15	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-9324101MX A SNJ54ABT16543W D	<a href="#">Samples</a>
SN74ABT16543DGGR	ACTIVE	TSSOP	DGG	56	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ABT16543	<a href="#">Samples</a>
SN74ABT16543DL	ACTIVE	SSOP	DL	56	20	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ABT16543	<a href="#">Samples</a>
SN74ABT16543DLR	ACTIVE	SSOP	DL	56	1000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ABT16543	<a href="#">Samples</a>
SNJ54ABT16543WD	ACTIVE	CFP	WD	56	15	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-9324101MX A SNJ54ABT16543W D	<a href="#">Samples</a>

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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**OTHER QUALIFIED VERSIONS OF SN54ABT16543, SN74ABT16543 :**

- Catalog : [SN74ABT16543](#)
- Military : [SN54ABT16543](#)

**NOTE: Qualified Version Definitions:**

- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications

## TAPE AND REEL INFORMATION



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ABT16543DGGR	TSSOP	DGG	56	2000	330.0	24.4	8.6	15.6	1.8	12.0	24.0	Q1
SN74ABT16543DLR	SSOP	DL	56	1000	330.0	32.4	11.35	18.67	3.1	16.0	32.0	Q1

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74ABT16543DGGR	TSSOP	DGG	56	2000	367.0	367.0	45.0
SN74ABT16543DLR	SSOP	DL	56	1000	367.0	367.0	55.0

## TUBE



\*All dimensions are nominal

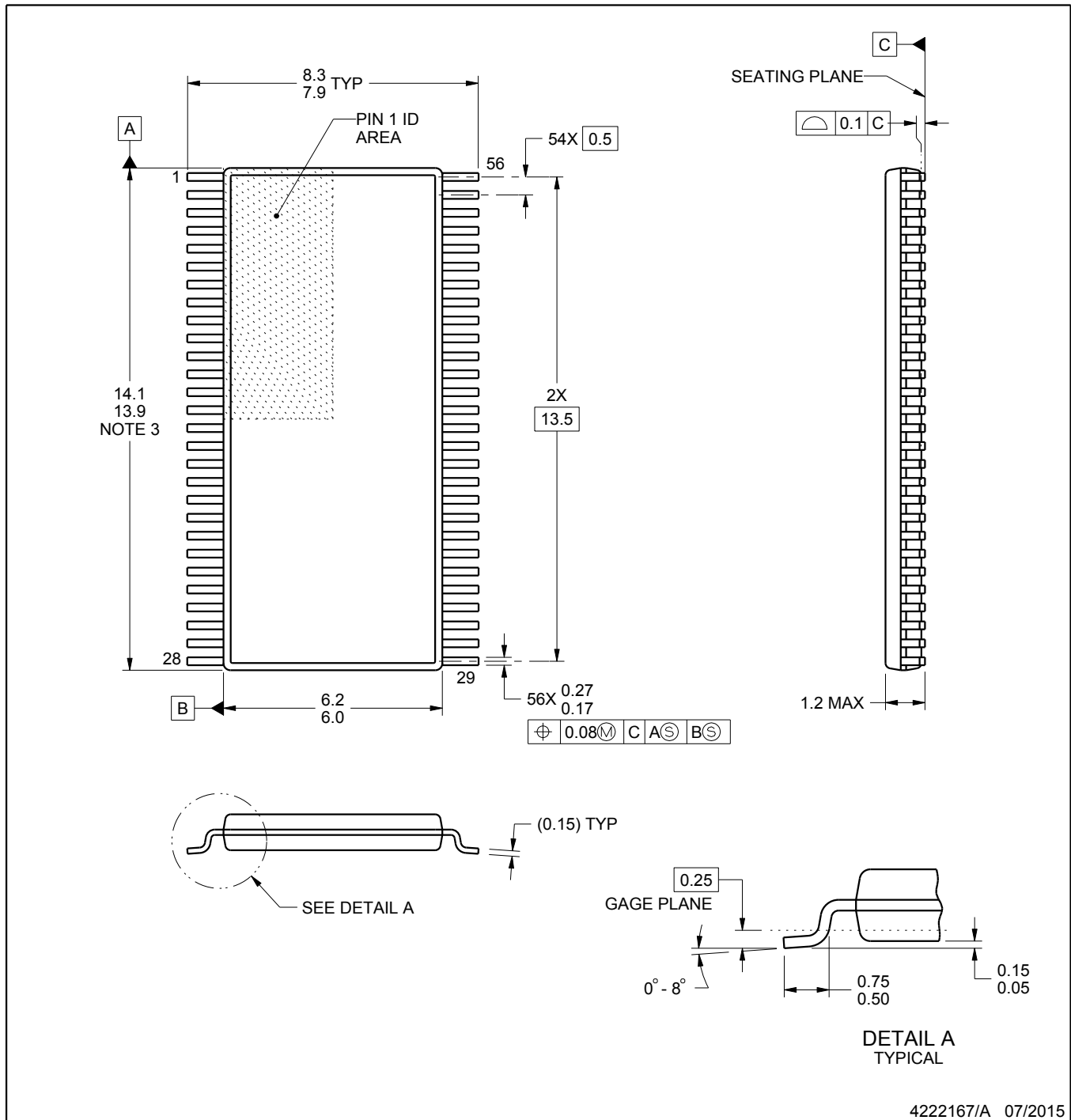
Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
SN74ABT16543DL	DL	SSOP	56	20	473.7	14.24	5110	7.87

DL (R-PDSO-G56)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion not to exceed  $0.006$  (0,15).
  - D. Falls within JEDEC MO-118



4222167/A 07/2015

## NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. Reference JEDEC registration MO-153.

# EXAMPLE BOARD LAYOUT

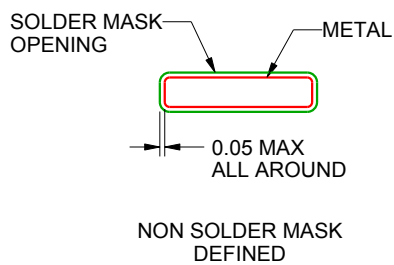
DGG0056A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
SCALE:6X



SOLDER MASK DETAILS

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NOTES: (continued)

5. Publication IPC-7351 may have alternate designs.

6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

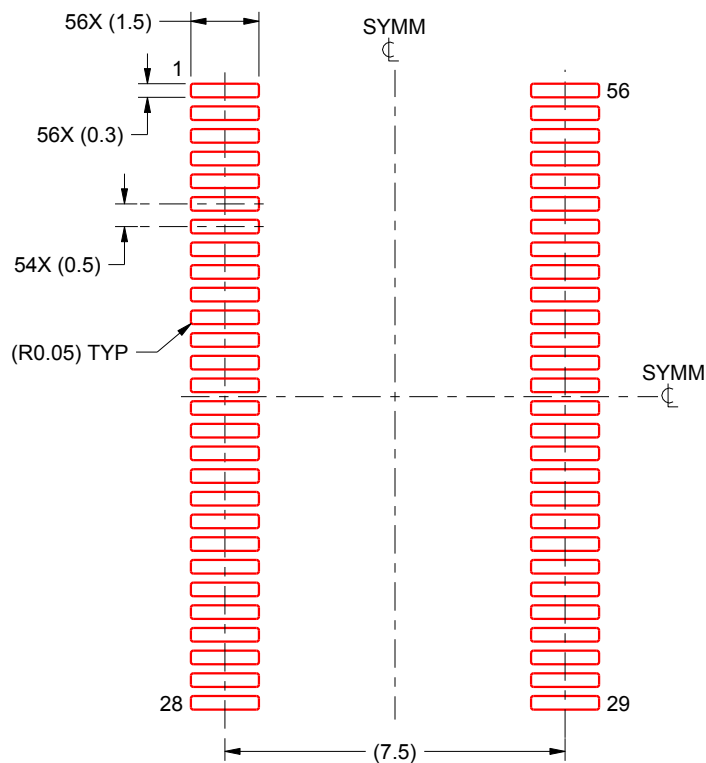


## EXAMPLE STENCIL DESIGN

DGG0056A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:6X

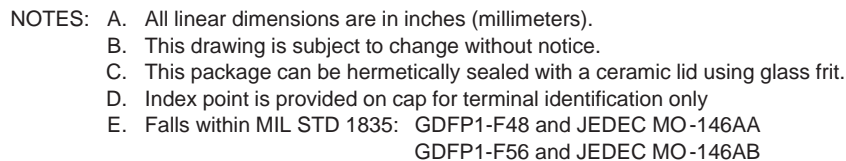
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NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

## CERAMIC DUAL FLATPACK

48 LEADS SHOWN



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